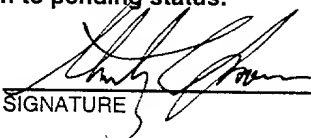


FORM PTO-1390 (REV 11-98)	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTORNEY'S DOCKET NUMBER 124-810
TRANSMITTAL LETTER TO THE UNITED STATES DESIGNATED/ELECTED OFFICE (DO/EO/US) CONCERNING A FILING UNDER 35 U.S.C. 371		U.S. APPLICATION NO. (If known, see 37 C.F.R. 1.5) 09/743039
INTERNATIONAL APPLICATION NO. PCT/GB99/02117	INTERNATIONAL FILING DATE 2 July 1999	PRIORITY DATE CLAIMED 4 July 1998
TITLE OF INVENTION INFRARED LIGHT EMITTING DIODES		
APPLICANT(S) FOR DO/EO/US ASHLEY et al.		
Applicant herewith submits to the United States Designated/Elected Office (DO/EO/US) the following items and other information:		
1. <input checked="" type="checkbox"/> This is a FIRST submission of items concerning a filing under 35 U.S.C. 371. 2. <input type="checkbox"/> This is a SECOND or SUBSEQUENT submission of items concerning a filing under 35 U.S.C. 371. 3. <input checked="" type="checkbox"/> This is an express request to begin national examination procedures (35 U.S.C. 371(f) at any time rather than delay examination until the expiration of the applicable time limit set in 35 U.S.C. 371(b) and PCT Articles 22 and 39(1). 4. <input checked="" type="checkbox"/> A proper Demand for International Preliminary Examination was made by the 19 th month from the earliest claimed priority date. 5. A copy of the International Application as filed (35 U.S.C. 371(c)(2)). a. <input type="checkbox"/> is transmitted herewith (required only if not transmitted by the International Bureau). b. <input checked="" type="checkbox"/> has been transmitted by the International Bureau. c. <input type="checkbox"/> is not required, as the application was filed in the United States Receiving Office (RO/US). 6. <input type="checkbox"/> A translation of the International Application into English (35 U.S.C. 371(c)(2)). 7. <input checked="" type="checkbox"/> Amendments to the claims of the International Application under <u>PCT Article 34</u> . a. <input type="checkbox"/> are transmitted herewith (required only if not transmitted by the International Bureau). b. <input checked="" type="checkbox"/> have been transmitted by the International Bureau. c. <input type="checkbox"/> have not been made; however, the time limit for making such amendments has NOT expired. d. <input type="checkbox"/> have not been made and will not be made. 8. <input type="checkbox"/> A translation of the amendments to the claims under PCT Article 19 (U.S.C. 371(c)(3)). 9. <input type="checkbox"/> An oath or declaration of the inventor(s) (35 U.S.C. 371(c)(4)). 10. <input type="checkbox"/> A translation of the annexes to the International Preliminary Examination Report under PCT Article 36 (35 U.S.C. 371(c)(5)). Items 11. To 16. Below concern document(s) or information included: 11. <input type="checkbox"/> An Information Disclosure Statement under 37 C.F.R. 1.97 and 1.98. 12. <input type="checkbox"/> An assignment document for recording. A separate cover sheet in compliance with 37 C.F.R. 3.28 and 3.31 is included. 13. <input checked="" type="checkbox"/> A FIRST preliminary amendment. <input type="checkbox"/> A SECOND or SUBSEQUENT preliminary amendment. 14. <input type="checkbox"/> A substitute specification. 15. <input type="checkbox"/> A change of power of attorney and/or address letter. 16. <input checked="" type="checkbox"/> Other items or information. PTO-1449/ International Search Report <input type="checkbox"/> This application is entitled to "Small entity" status. <input type="checkbox"/> "Small entity" statement attached.		

U.S. APPLICATION NO. (If known, see 37 C.F.R. 1.5)		INTERNATIONAL APPLICATION NO.		ATTORNEY'S DOCKET NUMBER	
Unknown 09/743039		PCT/GB99/02117		124-810	
17. <input checked="" type="checkbox"/> The following fees are submitted:				CALCULATIONS PTO USE ONLY	
BASIC NATIONAL FEE (37 C.F.R. 1.492(a)(1)-(5)): -- Neither international preliminary examination fee (37 C.F.R. 1.482) nor international search fee (37 C.F.R. 1.445(a)(2)) paid to USPTO and International Search Report not prepared by the EPO or JPO\$1000.00 -- International preliminary examination fee (37 C.F.R. 1.482) not paid to USPTO but International Search Report prepared by the EPO or JPO.....\$860.00 -- International preliminary examination fee (37 C.F.R. 1.482) not paid to USPTO but international search fee (37 C.F.R. 1.445(a)(2)) paid to USPTO\$710.00 -- International preliminary examination fee paid to USPTO (37 C.F.R. 1.482) but all claims did not satisfy provisions of PCT Article 33(1)-(4).....\$690.00 -- International preliminary examination fee paid to USPTO (37 C.F.R. 1.482) and all claims satisfied provisions of PCT Article 33(1)-(4).....\$100.00					
ENTER APPROPRIATE BASIC FEE AMOUNT =				\$	860.00
Surcharge of \$130.00 for furnishing the oath or declaration later than <input type="checkbox"/> 20 <input checked="" type="checkbox"/> 30 months from the earliest claimed priority date (37 C.F.R. 1.492(e)).				\$	130.00
CLAIMS	NUMBER FILED	NUMBER EXTRA	RATE		
Total Claims	16	-20 = 0	X \$18.00	\$	0.00
Independent Claims	2	-3 = 0	X \$80.00		0.00
MULTIPLE DEPENDENT CLAIMS(S) (if applicable)			\$270.00	\$	0.00
TOTAL OF ABOVE CALCULATIONS =				\$	990.00
Reduction by 1/2 for filing by small entity, if applicable. Small entity status must also be asserted. (Note 37 C.F.R. 1.9, 1.27, 1.28).					0.00
SUBTOTAL =				\$	990.00
Processing fee of \$130.00, for furnishing the English Translation later than <input type="checkbox"/> 20 <input type="checkbox"/> 30 months from the earliest claimed priority date (37 C.F.R. 1.492(f)).					0.00
TOTAL NATIONAL FEE =				\$	990.00
Fee for recording the enclosed assignment (37 C.F.R. 1.21(h)). The assignment must be accompanied by an appropriate cover sheet (37 C.F.R. 3.28, 3.31). \$40.00 per property				+	\$ 0.00
Fee for Petition to Revive Unintentionally Abandoned Application (\$1240.00 - Small Entity = \$620.00)				\$	0.00
TOTAL FEES ENCLOSED =				\$	990.00
				Amount to be:	
				refunded	\$
				Charged	\$
a. <input checked="" type="checkbox"/> A check in the amount of \$990.00 to cover the above fees is enclosed. b. <input type="checkbox"/> Please charge my Deposit Account No. 14-1140 in the amount of \$_____ to cover the above fees. A duplicate copy of this form is enclosed. c. <input checked="" type="checkbox"/> The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 14-1140. A duplicate copy of this form is enclosed. d. <input type="checkbox"/> The entire content of the foreign application(s), referred to in this application is/are hereby incorporated by reference in this application.					
NOTE: Where an appropriate time limit under 37 C.F.R. 1.494 or 1.495 has not been met, a petition to revive (37 C.F.R. 1.137(a) or (b)) must be filed and granted to restore the application to pending status.					
SEND ALL CORRESPONDENCE TO: NIXON & VANDERHYE P.C. 1100 North Glebe Road, 8 th Floor Arlington, Virginia 22201 Telephone: (703) 816-4000					
 SIGNATURE					
Stanley C. Spooner NAME					
27,393 REGISTRATION NUMBER		January 4, 2001 Date			

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

ASHLEY et al.

Atty. Ref.: 124-810

Serial No. Unknown

Group:

Filed: January 4, 2001

Examiner:

For: INFRARED LIGHT EMITTING DIODES

* * * * *

January 4, 2001

Assistant Commissioner for Patents
Washington, DC 20231

Sir:

PRELIMINARY AMENDMENT

In order to place the above-identified application in better condition for examination, please amend the application as follows:

IN THE CLAIMS

Claim 3, line 1, delete "or claim 2".

Claim 4, line 1, change "any one of the preceding claims" to --claim 1--.

Claim 5, line 1, change "any one of the preceding claims" to --claim 1--.

Claim 6, line 1, change "any one of the preceding claims" to --claim 1--.

Claim 7, line 2, change "any one of the preceding claims" to --claim 1--.

Claim 11, line 1, delete "or claim 10".

Claim 12, line 1, change "any one of claims 9 to 11" to --claim 9--.

Claim 13, line 1, change "any one of claims 9 to 12" to --claim 9--.

Claim 14, line 1, change "any one of claims 9 to 13" to --claim 9--.

Claim 15, line 3, change "any one of claims 9 to 14" to --claim 9--.

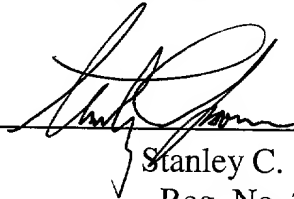
REMARKS

The above amendments are made to place the claims in a more traditional format.

Respectfully submitted,

NIXON & VANDERHYE P.C.

By: _____



Stanley C. Spooner
Reg. No. 27,393

SCS:ms
1100 North Glebe Road, 8th Floor
Arlington, VA 22201-4714
Telephone: (703) 816-4000
Facsimile: (703) 816-4100

INFRARED LIGHT EMITTING DIODES

This invention relates to semiconductor light emitting diodes (LEDs),
5 which emit electromagnetic radiation at infrared wavelengths. Infrared
LEDs have applications in the fields of telecommunications,
spectroscopy and, in particular, gas sensors.

Infrared gas sensor technology is well established and can give
10 selective and quantitative gas detection for a variety of gasses having
vibrational-rotational absorptions at wavelengths of between 3 and 12
microns. Existing infrared sources for gas sensors at infrared
wavelengths operate at high temperatures and thereby have a number
of drawbacks in intrinsic safety, wavelength range, stability and life.
15 Furthermore, existing sources emit pulses of infrared radiation at a
frequency which is limited by a maximum frequency of the order of
several Hertz which is not consistent with optimum working frequencies
of processing electronics and limits the type of infrared signal detector
which can be used in the gas sensor.

20 Recently developed infrared LEDs overcome the bulk of these problems
in gas sensor applications. The new infrared light emitting diodes are
intermittently positively biased in order to generate a series of pulses of
infrared radiation. However, the output power of these pulses is strongly
25 dependent on temperature. Accordingly, during use of such an infrared
LED in gas sensor arrangements, either the LED temperature has to be
monitored and the results mathematically corrected for temperature
changes or the LED temperature has to be stabilised. The normal
method for stabilising optical output power with respect to temperature
30 is the use of temperature control methods, such as the combination of
thermoelectric or Peltier cooling and temperature sensors. Therefore,

AK34

stabilising and/or monitoring temperature adds expense and complexity to the operation of infrared LEDs in gas detection applications.

5 A dynamic infrared scene projector comprising infrared light emitting diodes capable of emitting both positive and negative luminescence is discussed in International Patent Application Number PCT/GB96/02374. A gas sensor including an infrared light emitting diode which can emit both positive and negative luminescence is described in an article by C.H. Wang et al entitled "Detection of nitrogen dioxide using a room
10 temperature operation mid-infrared InSb light emitting diode" which was published in Electronics Letters, vol. 34, No. 3 (5 February 1998), pages 300-301.

15 The object of the present invention is to provide an infrared LED arrangement which does not require significant temperature stabilisation in order to operate in a stable manner.

Accordingly, a first aspect of the present invention provides an infrared light emitting diode arrangement comprising;

20 an infrared light emitting diode which emits positive luminescence when forward biased and negative luminescence when reverse biased, and

a drive means for supplying an alternating forward and reverse bias input to the light emitting diode;

25 characterised in that the levels of forward and reverse bias applied by the drive means are set so that at the forward bias input level the change in output power of the LED with temperature is substantially equal to and cancels out the change in the output power of the LED with temperature at the reverse bias input level over a selected temperature range so that the difference in output power between the positive

2a

luminescence and the negative luminescence of the light emitting diode is stabilised with respect to temperature.

According to a second aspect of the present invention there is provided a method of operating an infrared light emitting diode which emits positive luminescence in forward bias and negative luminescence in reverse bias, the method comprising supplying an alternating forward and reverse bias input to the light emitting diode characterised in that the levels of forward and reverse bias are selected so that the change in output power of the LED with temperature is substantially equal to and cancels out the change in the output power of the LED with temperature at the reverse bias input level over a selected temperature range so that the difference in output power between the positive luminescence and the negative luminescence of the light emitting diode is stabilised with respect to temperature.

The component of the output power emitted from the light emitting diode (LED) which varies with the alternating forward and reverse bias input therefore has a constant difference between the maximum (positive luminescence) and the minimum (negative luminescence) output power in each cycle of positive and negative luminescence, over a selected

- range of temperatures. Accordingly, if the minimum negative luminescence is used as a base level for measurements of output power, then the difference between this base level (which will change with temperature) and the maximum level of positive luminescence (which will also change with temperature) will remain constant over a selected range of temperatures for each cycle of positive and negative luminescence. The thus temperature stabilised alternating output power can be used as the source in various infrared applications, in particular in gas sensors, with little or no external temperature control.
- 10 The infrared diode arrangement according to the present invention can also increase the amplitude of the usable infrared signal, because the negative luminescence pulse can be used as well as the positive luminescence pulse, for example, in gas sensor applications.
- This can be understood with reference to Figure 4a which shows the variation of positive luminescence and negative luminescence (inverted) with temperature for a sample infrared LED and Figure 4b which shows a single positive and negative luminescence cycle for a sample infrared LED at two difference temperatures. It can be seen in Figure 4a that positive luminescence (emission in forward bias), for the semiconductor infrared LED measured in Figure 4a decreases steadily with an increase in temperature in the range of at least 0 to 50°C. This is as a consequence of the ratio of the temperature dependencies of the radiative and dominant non-radiative recombination mechanisms within the LED. This is also shown in Figure 4b, in which at 10°C the output power in positive luminescence is P_{P1} and at 25°C the output power in positive luminescence is reduced to P_{P2} . For negative luminescence (emission in reverse bias), it can be seen from Figure 4a, that there is a steady increase in intensity with temperature from below 0°C to approximately 35°C. This is a consequence of the LED being under reverse saturation over this temperature range so that the negative luminescence intensity is primarily related to radiative processes within

the LED. This is also shown in figure 4b, in which at 10°C the output power in negative luminescence is P_{N1} and at 25°C the output power in negative luminescence has a greater intensity (ie. is more negative) at P_{N2} . However, by selecting the correct bias level for forward and reverse bias, over selected temperature ranges, the change in positive luminescence from 10°C to 25°C can be made substantially the same as and cancelled out by the change in negative luminescence. This gives rise to a constant difference between output power of the positive luminescence and the negative luminescence for each cycle. This is shown in Figure 4b, because $dP_1 = dP_2$.

Therefore, it is preferred that the level of forward and reverse bias are chosen so that in forward bias the change in output power of the LED with temperature is substantially equal to and cancels out the change in output power of the LED with temperature in reverse bias, over a selected temperature range.

By operating the LED measured in Figure 4a with an alternate forward and reverse bias input so that the LED operates with alternate positive and negative luminescence the temperature dependencies shown in Figure 4a can be made to cancel each other out in selected temperature ranges between 0°C and 35°C. Thus the sensitivity to temperature of the difference in output power between positive luminescence and negative luminescence is reduced. The temperature ranges over which reduced sensitivity to temperature is achieved correspond to the practical operating temperatures of infrared LEDs. This enables the LED arrangement according to the present invention to be operated with much simplified temperature stabilisation techniques.

In order to improve temperature stabilisation, the alternating forward and reverse bias input alternates regularly. In particular it is preferred that the period and/or intensity of forward bias input is substantially the same in consecutive cycles of positive luminescence and the period and/or

intensity of reverse bias input is substantially the same in consecutive cycles of negative luminescence. However, the period and/or intensity of forward bias input does not have to be the same as the respective period and/or intensity of the reverse bias input.

- 5 In order to achieve maximum output power, while still achieving temperature stabilisation, the reverse bias level is chosen so that it gives the maximum negative luminescence, at the maximum temperature in a selected temperature range of operation. Then the forward bias level is chosen as described above. The positive and negative luminescence of
- 10 the LEDs described herein increase with applied bias levels, for example, with increased bias current, until saturation occurs in reverse bias. Therefore, in order to achieve the maximum output powers while still achieving temperature stabilisation it is preferred that the reverse bias level is chosen to be the minimum necessary to give a current close
- 15 to the saturation current.

- In a preferred embodiment the frequency of the alternating bias input signal is at least 1 Hz and preferably at least 5 Hz. The frequency of the alternating bias input signal must be high enough so that temperature dependent changes in output power during a half cycle of the signal (ie.
- 20 temperature dependant output power changes during each period of forward bias or reverse bias) are negligible. The upper limit to the frequency is limited only because the response of the infrared LED to the change between forward and reverse bias is not instantaneous. The present invention should be effective up to frequencies of at least
- 25 several tens of megahertz.

In a preferred embodiment the light emitting diode emits radiation at infrared wavelengths in the range of 3 to 13 microns.

In a further preferred embodiment the light emitting diode is formed from a narrow bandgap semiconductor material.

According to a third aspect of the present invention there is provided a sensor device including an infrared light emitting diode which is temperature stabilised as described above. The light emitting diode according to the present invention is suitable for use in most types of
5 sensors requiring an infrared source, in particular gas sensors.

The present invention provides a temperature stabilised infrared light emitting diode arrangement comprising; an infrared light emitting diode, and a drive means for supplying an alternating forward and reverse bias input to the light emitting diode.
10

The present invention will now be described with reference to the following Figures in which:

Figure 1 shows schematically the structure of a semiconductor infrared light emitting diode (LED) suitable for use in the
15 arrangement according to the present invention.

Figure 2 graphically illustrates the variation in conduction band and valence band edge energies along the LED of Figure 1.
20

Figure 3 schematically illustrates a semiconductor heterostructure as grown to produce the device of Figure 1.

Figure 4a is a graph showing the temperature dependence
25 of the positive luminescence of the output power of the type of LED shown in Figure 1 in forwards bias and the negative luminescence of the type of LED shown in Figure 1 in reverse bias.

Figure 4b shows single cycles of positive and negative
30 luminescence for the type of LED shown in Figure 1 at temperatures of 10°C and 25°C.

Figure 5 schematically shows the drive circuit for the LED of Figure 1.

5 Figure 6 shows a square wave voltage drive signal which can be input into the drive circuit of Figure 5.

10 Figure 7 schematically shows a gas detector which uses the LED of Figure 1.

15 Figures 8a to 8c show the temperature dependence of the difference in output power between positive and negative luminescence of the LED arrangement according to the present invention.

20 Figure 9 shows the output emission spectra of three samples of the type of LED shown in Figure 1.

Referring firstly to Figure 3, there is shown schematically a semiconductor heterostructure (10) suitable for constructing an LED according to the present invention. The heterostructure (10) is based on narrow bandgap material Indium Antimonide (InSb) and comprises Indium Antimonide (InSb) and Indium Aluminium Antimonide ($\text{In}_{1-x}\text{Al}_x\text{Sb}$) alloys. Alternative suitable heterostructures could be based, for example, on narrow bandgap material Mercury Cadmium Telluride or Mercury Zinc Telluride.

There are four regions of semiconductor material; a heavily doped p-type (p^+) region (12), a relatively wide bandgap heavily doped p-type (p^+) region (14), a lightly doped p-type (p^-) region (16) and a heavily doped n-type (n^+) region (18). In this specification a superscript minus (-) or plus (+) indicates light or heavy doping respectively and the absence of a superscript indicates an intermediate doping level. The bar (—)

subscript indicates material of wide bandgap relative to the bandgap of material denoted without a bar subscript. The structure (10) has p^+p^+ heterojunction (20), p^+p^- heterojunction (22) and p^-n^+ homojunction (24).

- 5 It should be noted that the lightly doped p-type (p^-) region (16) could alternatively comprise a lightly doped n-type (n^-) material.

The heterostructure (10) is grown in a MBE system on an InSb substrate (26). Adjacent to the substrate (26) is a buffer and
10 temperature ramp region (28) grown whilst the MBE system is being set up correctly to grow heterostructure (10). The growth temperature is approximately 420°C and the growth rate is 0.5microns/hr. Mesa diode fabrication is performed using standard photolithographic techniques, on the heterostructure (10), to define chemically etched structures.

- 15 The p^+ region (12) has a width of approximately 2 microns, the p^- region (16) has a width of around 1 to 3 microns and the n^+ region (18) has a width of approximately 1 micron and all are made from InSb which has a bandgap of 0.17eV at room temperature. The p^+ region (14) is made of $In_{0.85}Al_{0.15}Sb$ and has a width of 0.02 microns. $In_{0.85}Al_{0.15}Sb$ has a
20 bandgap at room temperature of 0.43eV, more than twice the bandgap of InSb. Dopants are Silicon (Si) for n-type and Beryllium (Be) for p-type. Doping in regions (12) and (14) is 5×10^{18} atoms/cm³, in region (16) is 1×10^{15} atoms/cm³ and in region (18) is 3×10^{18} atoms/cm³.

- Referring now to Figure 1, there is shown schematically a
25 semiconductor LED (30). Parts common to Figures 1 and 3 are like referenced. As will be described later the p^+p^- junction (22) forms an accumulating contact in forward bias and an excluding contact in reverse bias. The p^-n^+ junction (24) forms an injecting contact in forward bias and an extracting contact in reverse bias. Electrodes to the
30 diode (30) are provided at (32) and (34) for bias voltage application.

Region (12) provides a narrow bandgap region to which electrode (32) may be attached and the width of this region should be greater than the electron diffusion length, ie. greater than approximately 100nm. Region (14) must have sufficient width such that minority carriers are substantially prevented from tunnelling between region (16) to region (12), ie. wider than about 10nm.

Figure 2 shows curves (40) and (42) illustrating graphically the variation in conduction and valance band edge energies E_c and E_v respectively, along the diode (10), at zero bias. Dotted lines (44),(46) and (48) indicate the positions of junctions (20), (22) and (24) respectively. A dashed line (50) indicates the Fermi level E_F through the diode (30). The p^+ region (14) generates potential barrier (52) in the conduction band E_c which prevents minority carriers (electrons) from the p^- region (16) entering the p^+ region (12).

The light emitting diode (30) operates as follows. When a forward bias is applied by making contact (32) have a positive voltage with respect to contact (34) majority carriers from each side of the p^-n^+ junction (24) cross the junction and enter the material at the other side where they are minority carriers. In this way electrons cross from the n^+ region (18) in which they are majority carriers into the p^- region (16) in which they are minority carriers and so cause an increase in the minority carrier population. The excess minority carriers in the p^- region diffuse away from the p^-n^+ junction (24) but the build up of minority carriers in the p^- region (16) is very efficient because the minority carriers in the p^- region are accumulated at the p^+ region (14) by potential barrier (52). The excess minority carriers in the p^- region radiatively recombine with majority carriers and as they do so generate photons of infrared wavelength which are emitted by the diode (30). This causes the positive luminescence of the diode (30).

In reverse bias, when contact (32) has a negative voltage with respect to contact (34), minority carriers from each side of the p^-n^+ junction (24) cross the junction and enter the material at the other side where they are majority carriers. In this way electrons from the p^- region (16) in which they are minority carriers cross into the n^+ region (18) in which they are majority carriers and so cause a decrease in the minority carrier population of the p^- region (16). This extraction of minority carriers from the p^- region (16) is very efficient because minority carriers from the p^+ region (12) are prevented from travelling into the p^- region (16) by the potential barrier (52). The reduction of minority carriers in the low doped p^- region has the effect of reducing radiative emission events occurring in the p^- region (16) and causes the relative negative luminescence of the diode (30).

The material and doping for at least the region (18) are chosen so that region (18) is transparent to the photons generated by recombination of electron hole pairs in the p^- region (16). In this way the photons generated in the p^- region (16) can be coupled directly out of the p^- region (16) and indirectly out of the n^+ region (18).

Figure 4a shows at line (a) the variation of the output power emitted with temperature in $^{\circ}\text{C}$ for an LED similar to LED (30) of Figure 1 when forward biased with an 100mA positive square wave drive current at 1kHz. The strong dependence of output power on temperature is apparent from Figure 4a, and it can be seen that the output power reduces approximately linearly with increase in temperature between approximately 0 and 50°C . Figure 4a also shows at line (b) the variation of the negative luminescence (inverted about the temperature axis) with temperature in $^{\circ}\text{C}$ for the same LED when reversed biased with an 100mA positive square wave drive current at 1kHz. It can be seen that the inverted negative luminescence increases approximately linearly with increase in temperature between approximately 0 and 35° .

According to the present invention the LED (30) is driven with an alternating polarity bias current, between positive luminescence condition and negative luminescence in order to achieve the temperature stabilisation of the difference between output power in positive and negative luminescence.

This is shown in Figure 4b, in which at 10°C the output power in positive luminescence is P_{P1} and at 25°C the output power in positive luminescence is reduced to P_{P2} . Comparing this to Figure 4b, in which at 10°C the output power in negative luminescence P_{N1} and at 25°C the output power in negative luminescence has a greater intensity (ie. is more negative) at P_{N2} . It can be seen that by selecting the correct bias current for forward and reverse bias, over selected temperature ranges, the change in positive luminescence from 10°C to 25°C is substantially the same as and cancelled out by the change in negative luminescence. This gives rise to a constant difference between the positive luminescence and the negative luminescence in each cycle as is shown in Figure 4b, because $dP_1 = dP_2$.

Referring now to Figure 5, which shows the light emitting diode (30) in a simple drive circuit. The signal input across input terminals (34) is shown in Figure 6 and comprises an alternating positive and negative square wave signal with a voltage V which varies between $+v_1$ and $-v_2$ with time t at a frequency of 10Hz. When the voltage across the diode (30) is $+v_1$, the diode is forwardly biased and so emits a pulse of infra red positive luminescence (for example, as shown in figure 4b at (60,62)). When the voltage across the diode (30) is $-v_2$, the diode is reverse biased and emits a pulse of negative luminescence (for example, as shown in Figure 4b at (64,66)). By alternating between $+v_1$ and $-v_2$ the temperature dependence of the difference in output power between a pulse of positive luminescence and a consecutive pulse of negative luminescence of the LED (30) is substantially reduced (for example, in Figure 4b dP_1 at 10°C is equal to dP_2 at 25°C) over certain

temperature ranges, in particular, within the temperature range of 0°C to 35°C.

Figures 8a to 8c show graphs of the difference in total output power between consecutive pulses of positive and negative luminescence against temperature for a LED of the type described above when it is driven by a positive and negative alternating square wave voltage signal of frequency 10kHz as described above. In Figure 8a the forward bias current is 100mA and the reverse bias current is 70mA. As can be seen from Figure 8a the difference in output power is substantially constant over a temperature range A of approximately 3°C, at approximately 20 to 23°C. In Figure 8b the forward bias current applied to the LED is 100mA and the reverse bias current is 60mA. As can be seen from Figure 8b the difference in output power is substantially constant over a temperature range B of approximately 5°C, at approximately 15 to 20°C. Finally, in Figure 8c the forward bias current applied to the LED is 100mA and the reverse bias current is 50mA. As can be seen from Figure 8c the difference in output power is substantially constant over a temperature range C of approximately 5°C, at approximately 10 to 15°C.

So far it has been found that using different ratios of forward and reverse bias current, the diode (30) can be operated so that over a temperature range of up to 6°C the difference in power of the infrared signal output from the diode changes by less than 0.2%. The diode (30) can also be operated with a forward bias current of 100mA and a reverse bias current of 50mA so that over a temperature range of up to 14°C the difference in power of the infrared signal output from the diode changes by less than 1% (See Figure 8c). Also, by using different ratios of forward and reverse bias current the substantially constant temperature ranges A, B and C which are discussed above can be shifted in temperature by up to 10°C. This is shown in Figure 8c in which the middle of the stable temperature region is approximately 12.5°C as compared to Figure 8a in which the middle of the stable

temperature region is 21.5°C. Furthermore the noise for these readings was less than 0.7% of the output signal strength.

The temperature ranges discussed above over which reduced sensitivity to temperature is attained, correspond to practical operating
5 temperatures and enable the LED arrangement according to the present invention to be stabilised with a simple thermo-electric cooler.

The output emission spectra of three samples of the type of LED (30) shown in Figure 1, are shown in Figure 9. Spectrum A is that of an InSb infrared diode of the type described above in relation to Figures 1 and 3
10 and spectra B and C are those of two different HgCdTe infrared diodes. As a source it can be seen that the InSb diode would be useful in the detection of NO and NO₂ gases because vibrational-rotational absorption spikes characteristic of NO and NO₂ gasses lie within the spectrum A. Similarly, the HgCdTe diode with spectrum B would be
15 useful in the detection of NO₂ and SO₂ gasses and the HgCdTe diode with spectrum C would be useful in the detection of SO₂ and O₃ gasses.

It should be noted that the difference in output power between positive and negative luminescence for different wavelengths in the spectra of these infrared diodes do not vary independently with temperature and
20 so when the total difference in output power of the LED (30) remains substantially constant over a range of temperatures, so will the difference in output power at any wavelength.

Figure 7 shows schematically a simple design of infrared gas sensor (40) in which the LED arrangement according to the present invention
25 can be used. The sensor (40) comprises a LED (30) as described above and driven as described above and with spectrum A of Figure 9. The light emitted from the LED (30) is directed into a cylindrical light pipe (42) by a parabolic reflector (44). An amount of gas, for example NO₂ gas, to be analysed is introduced into the pipe (42). The LED (30)

emits radiation at frequencies which correspond to the difference between vibration-rotational energy levels of the molecules of the NO₂ gas to be detected (See Figure 9). If the gas in the pipe (42) contains some NO₂ some of the light emitted from the LED (30) at a characteristic wavelength of approximately 6.2 microns will be absorbed by the gas. This is because photons of light emitted by the diode will excite NO₂ gas molecules to a higher vibration-rotational energy level. Thus, a detector arrangement (46) located at the opposite end of the pipe (42) to the LED (30) will detect a signal of reduced power at the characteristic wavelength of 6.2 microns associated with the NO₂ gas.

The detector arrangement (46) may comprise one or more filters (48) which are located in front of respective detectors (50). The combination of the output spectrum of the LED (30) and the range of frequencies passed by a particular filter (48) can be used to ensure that the light reaching a particular detector (50) is associated with a characteristic absorption wavelength of a particular gas so that the strength of the signal detected by a particular detector (50) can determine whether and in what amounts the associated gas is present in the pipe (42).

ART 34

CLAIMS

1. An infrared light emitting diode (LED) arrangement comprising:

an infrared LED (30) which emits positive luminescence
when forward bias and emits negative luminescence when
reverse biased;

a drive means for supplying an alternating forward and
reverse bias input to the LED;

characterised in that the levels of forward ($+v_1$) and reverse bias ($-v_2$)
applied by the drive means are set so that at the forward bias input level
the change in output power of the LED with temperature is substantially
equal to and cancels out the change in the output power of the LED with
temperature at the reverse bias input level, over a selected temperature
range so that the difference in output power between the positive
luminescence and the negative luminescence of the light emitting diode
is stabilised with respect to temperature.

2. An arrangement according to claim 1 wherein the alternating forward
and reverse bias input alternates regularly.

3. An arrangement according to claim 1 or claim 2 wherein the period
and intensity of the forward bias input is substantially the same in
consecutive cycles of positive luminescence and the period and
intensity of the reverse bias input is substantially the same in
consecutive cycles of negative luminescence.

4. An arrangement according to any one of the preceding claims
wherein the reverse bias input applied to the LED (30) is such that it
generates the maximum level of negative luminescence in the LED, at
the maximum temperature of a selected temperature range of operation.

5. An arrangement according to any one of the preceding claims wherein the light emitting diode (30) emits radiation at infrared wavelengths in the range of 3 to 13 microns.

6. An arrangement according to any one of the preceding claims wherein the light emitting diode (30) is formed from a narrow bandgap semiconductor material.

7. A sensor (40) including an infrared light emitting diode arrangement according to any of the preceding claims.

8. A sensor according to claim 7 wherein the sensor is a gas sensor.

9. A method of operating an infrared light emitting diode (LED) (30) which emits positive luminescence when forward biased and emits negative luminescence when reverse biased, comprising supplying an alternating forward ($+v_1$) and reverse ($-v_2$) bias input to the light emitting diode characterised in that the levels of forward and reverse bias are selected so that the change in the output power of the LED with temperature at the forward bias input level is substantially equal to and cancels out the change in the output power of the LED with temperature at the reverse bias input level, over a selected temperature range so that the difference in output power between positive luminescence and negative luminescence of the light emitting diode is stabilised with respect to temperature.

10. A method according to claim 9 wherein the alternating forward and reverse bias input alternates regularly.

11. A method according to claim 9 or claim 10 wherein the period and intensity of the forward bias input is substantially the same in consecutive cycles of positive luminescence and the period and intensity of the reverse bias input is substantially the same in consecutive cycles of negative luminescence.

12. A method according to any one of claims 9 to 11 wherein the reverse bias input applied to the LED (30) is such that it generates the maximum level of negative luminescence in the LED, at the maximum temperature in a selected temperature range of operation.

5 13. A method according to any one of claims 9 to 12 wherein the light emitting diode (30) emits radiation at infrared wavelengths in the range of 3 to 13 microns.

14. A method according to any one of claims 9 to 13 wherein the minimum level of negative luminescence of the LED is used as a base
10 level for measurements of the output power of the LED.

15. A method of operating a sensor (40) comprising an infrared light emitting diode (LED) (30) by operating the LED according to the method of any one of claims 9 to 14.

16. A method according to claim 15 wherein the sensor is a gas sensor.

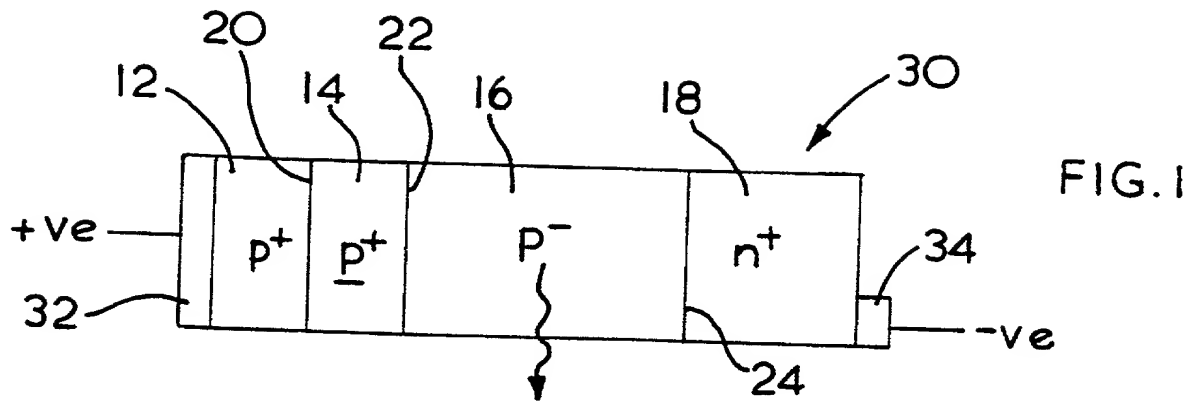


FIG. 1

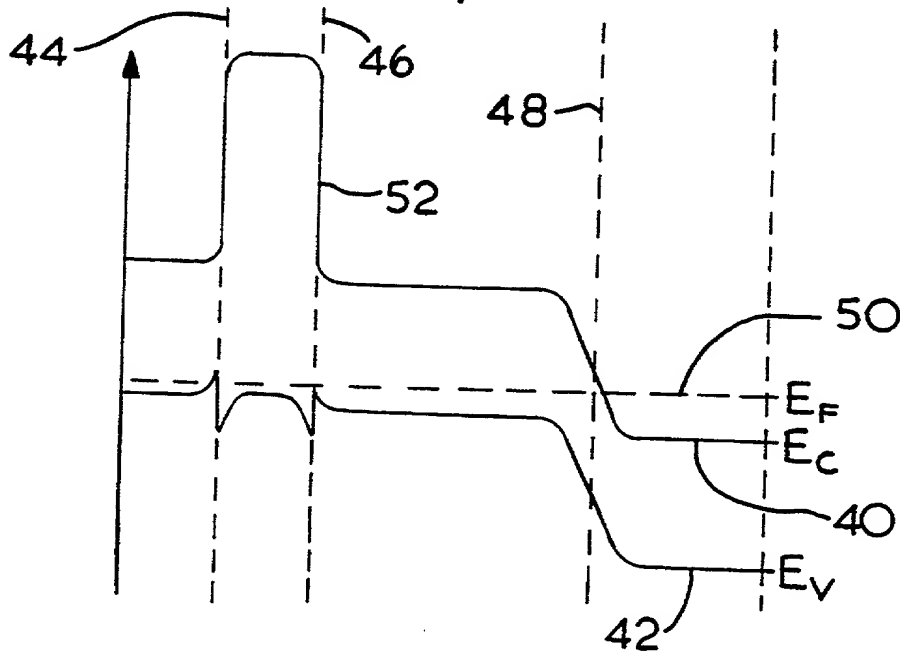


FIG. 2

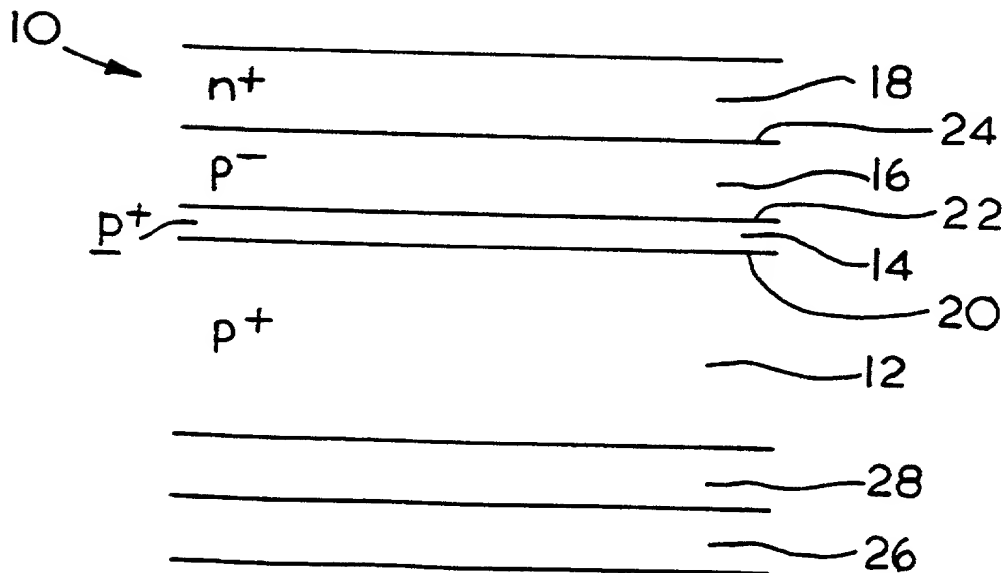


FIG. 3

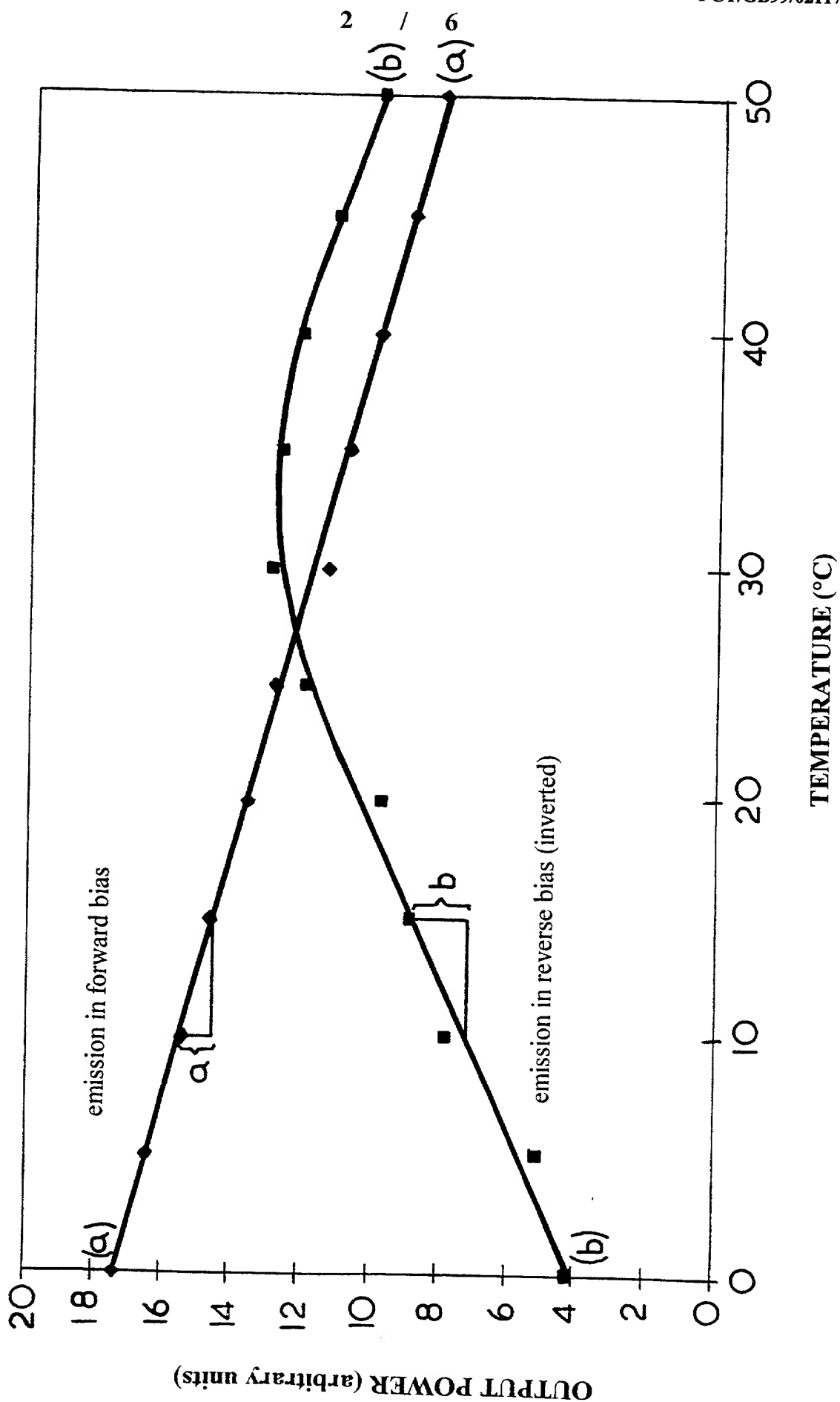


FIG. 4a

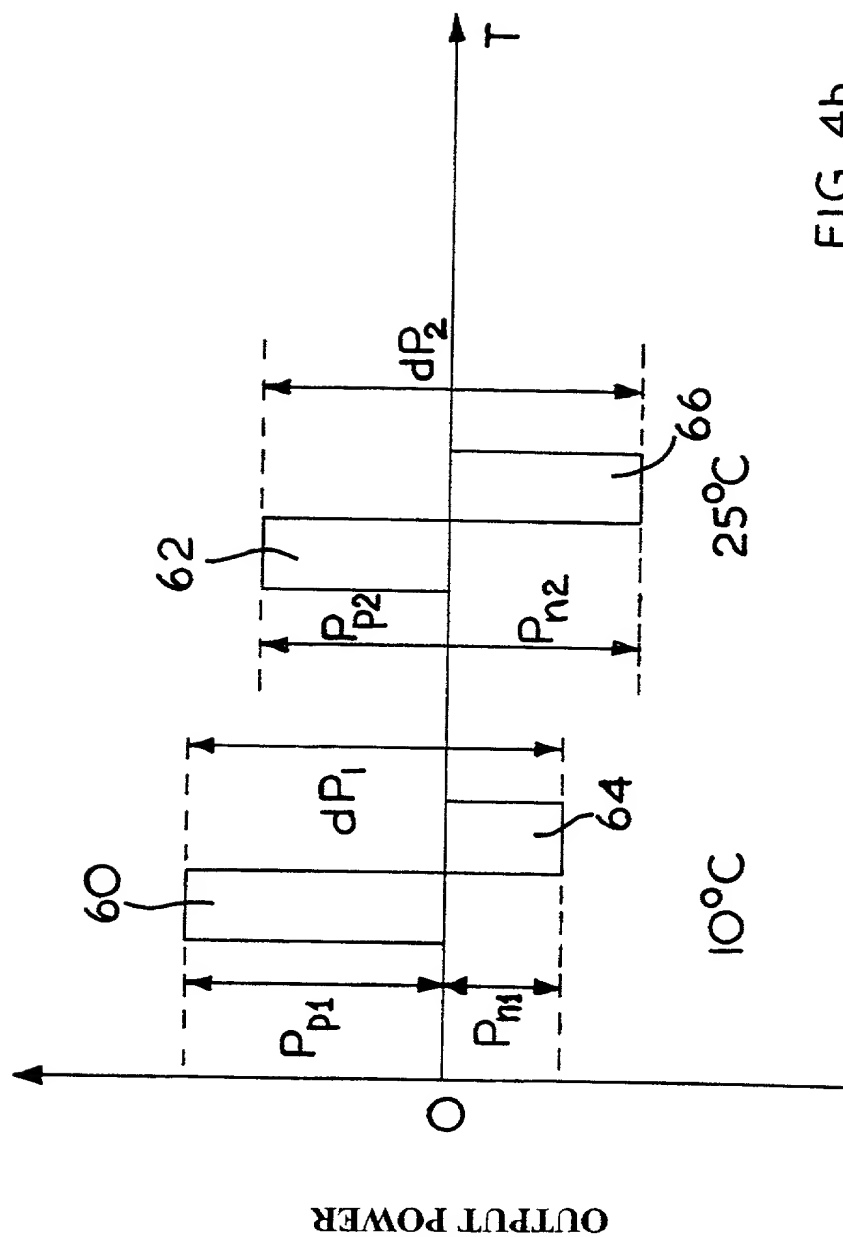


FIG. 4b

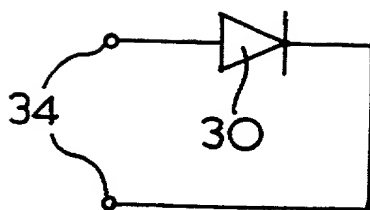


FIG. 5

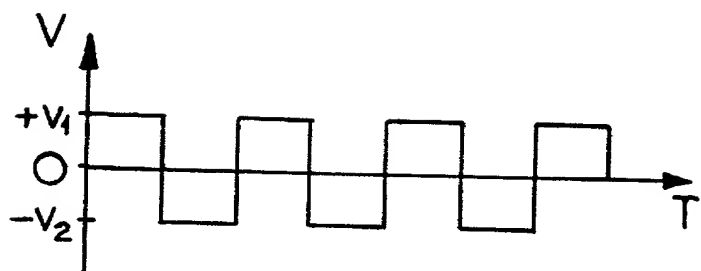


FIG. 6

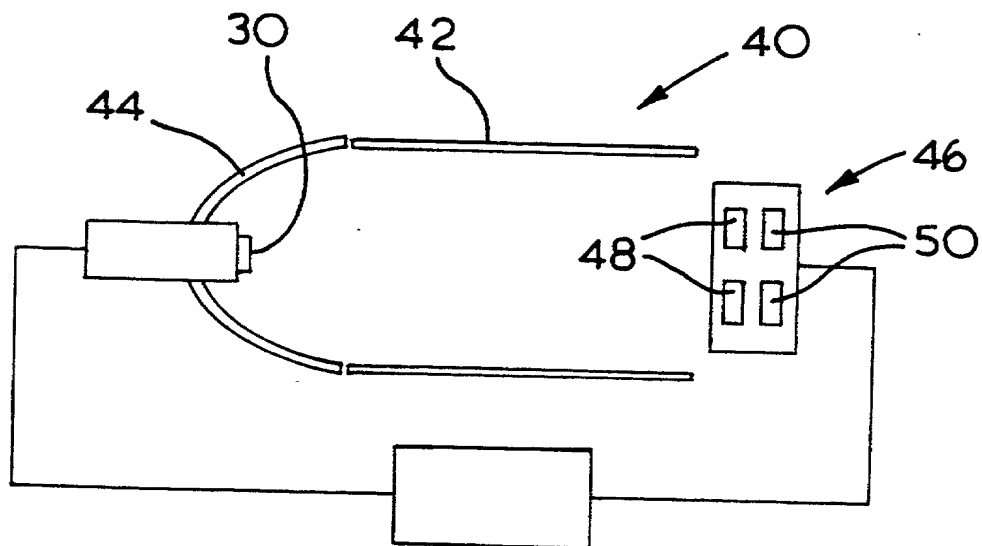


FIG. 7

NORMALISED OUTPUT POWER

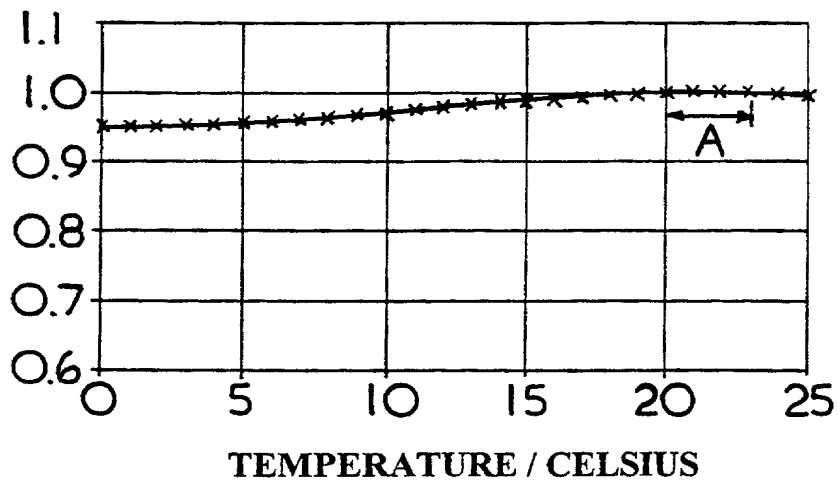


FIG. 8a

NORMALISED OUTPUT POWER

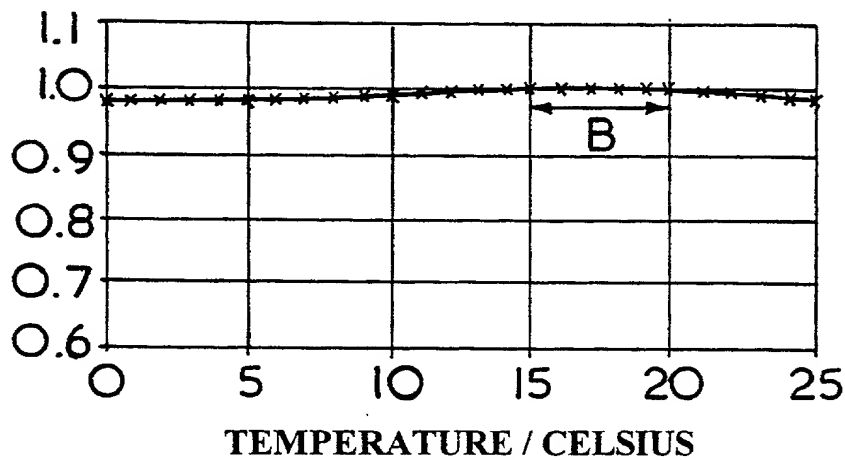


FIG. 8b

NORMALISED OUTPUT POWER

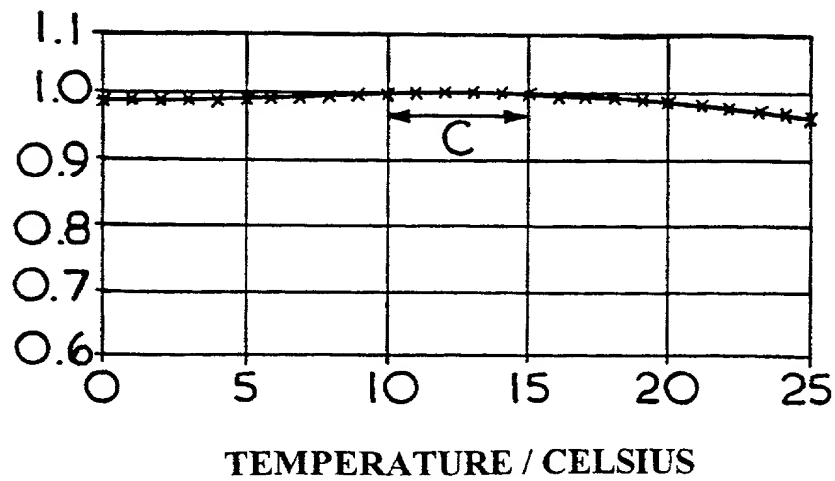


FIG. 8c

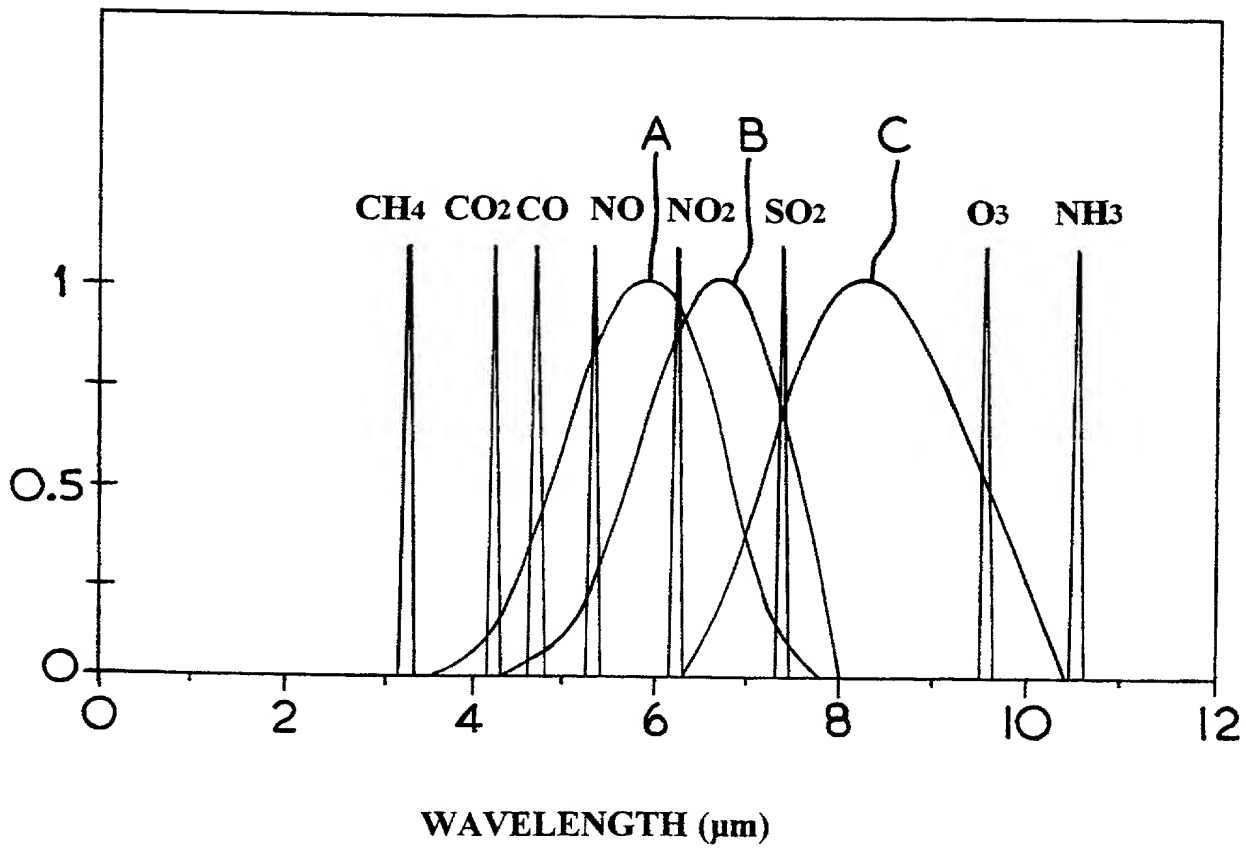


FIG. 9

RULE 63 (37 C.F.R. 1.63)
DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name, and I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Infrared Light Emitting Diodes

the specification of which (check applicable box(es)):

☐ is attached hereto

☐ was filed on _____

☒ was filed as PCT international application No. _____

and (if applicable to U.S. or PCT application) was amended on _____

as U.S. Application Serial No. _____

PCT/GB99/02117

on 02/07/1999

07/07/2000

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with 37 C.F.R. 1.56. I hereby claim foreign priority benefits under 35 U.S.C. 119/365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed or, if no priority is claimed, before the filing date of this application:

Priority Foreign Application(s):

Application Number

Country

Day/Month/Year Filed

9814462.9

GB

04/07/1998

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below.

Application Number

Date/Month/Year Filed

I hereby claim the benefit under 35 U.S.C. 120/365 of all prior United States and PCT international applications listed above or below and, insofar as the subject matter of each of the claims of this application is not disclosed in such prior applications in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose material information as defined in 37 C.F.R. 1.56 which occurred between the filing date of the prior applications and the national or PCT international filing date of this application:

Prior U.S./PCT Application(s):

Application Serial No.

Day/Month/Year Filed

Status: patented
pending, abandoned

PCT/GB99/02117

02/07/1999

PENDING

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. And I hereby appoint **NIXON & VANDERHYE P.C., 1100 North Glebe Rd., 8th Floor, Arlington, VA 22201-4714, telephone number (703) 816-4000 (to whom all communications are to be directed)**, and the following attorneys thereof (of the same address) individually and collectively my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent: Arthur R. Crawford, 25327; Larry S. Nixon, 25640; Robert A. Vanderhye, 27076; James T. Hosmer, 30184; Robert W. Faris, 31352; Richard G. Besho, 22770; Mark E. Nusbaum, 32348; Michael J. Keenan, 32106; Bryan H. Davidson, 30251; Stanley C. Spooner, 27393; Leonard C. Mitchard, 29009; Duane M. Byers, 33363; Jeffery H. Nelson, 30481; John R. Lastova, 33149; H. Warren Burnam, Jr. 29366; Thomas E. Byrne, 32205; Mary J. Wilson, 32955; J. Scott Davidson, 33489; Alan M. Kagen, 36178; William J. Griffin, 31260; Robert A. Molan, 29834; B. J. Sadoff, 36663; James D. Berquist, 34776; Updeep S. Gill, 37334; Michael J. Shea, 34725; Donald L. Jackson, 41090; Michelle N. Lester, 32331.*

1.	Inventor's Signature:	_____	Date:	_____
	Inventor:	Timothy (first) MI ASHLEY (last) GB (citizenship)		
	Residence: (city)	Malvern (state/country) GB		
	Post Office Address:	Defence Evaluation & Research Agency St Andrews Road, Malvern Worcs		
	(Zip Code)	WR14 3PS		
2.	Inventor's Signature:	_____	Date:	28 Nov 2000
	Inventor:	John (first) MI CROWDER (last) GB (citizenship)		
	Residence: (city)	Edinburgh (state/country) GB		
	Post Office Address:	1 Clerwood View Edinburgh		
	(Zip Code)	EH12 8PH		

FOR ADDITIONAL INVENTORS, check box ☒ and attach sheet with same information and signature and date for each.

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Nixon & Vanderhye P.C. (12/95)

Page 2

3. Inventor's Signature: 30 S D Smith Date: 12/14/2007
Inventor: Stanely D SMITH GB
(first) (last) (citizenship)
Residence: (city) Edinburgh GB (state/country)
Post Office Address: Tree Tops, 29 Gillespie Road, Colinton, Edinburgh
(Zip Code) EH13 0NW
4. Inventor's Signature: _____ Date: _____
Inventor: H-O Volker P MANNHEIM DE
(first) (last) (citizenship)
Residence: (city) Jever Germany (state/country)
Post Office Address: Am Kirchplatz 25 Germany
(Zip Code) D-26441
5. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
6. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
7. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
8. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
9. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
10. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
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Infrared Light Emitting Diodes

the specification of which (check applicable box(es)):

☐ is attached hereto
☐ was filed on _____ as U.S. Application Serial No. _____
☒ was filed as PCT International application No. PCT/GB99/02117 on 02/07/1999
and (if applicable to U.S. or PCT application) was amended on 07/07/2000

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with 37 C.F.R. 1.56. I hereby claim foreign priority benefits under 35 U.S.C. 119/365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed or, if no priority is claimed, before the filing date of this application:

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9814462.9	GB	04/07/1998

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Application Number	Date/Month/Year Filed

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Prior U.S./PCT Application(s):

Application Serial No.	Day/Month/Year Filed	Status: patented pending, abandoned
PCT/GB99/02117	02/07/1999	PENDING

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1. Inventor's Signature: [Signature] Date: 1st Dec 00
Inventor: Timothy ASHLEY GB
(first) (last) (citizenship)
Residence (city) Malvern (state/country) GB
Post Office Address: Defence Evaluation & Research Agency St Andrews Road, Malvern Worcs
(Zip Code) WR14 3PS

2. Inventor's Signature: [Signature] Date: _____
Inventor: John CROWDER GB
(first) (last) (citizenship)
Residence (city) Edinburgh (state/country) GB
Post Office Address: 1 Clerwood View Edinburgh
(Zip Code) EH12 8PH

FOR ADDITIONAL INVENTORS, check box ☒ and attach sheet with same information and signature and date for each.

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Nixon & Vanderhye P.C. (12/95)

Page 2

3. Inventor's Signature: _____ Date: _____
Inventor: Stanley D Smith GB
(first) MI (last) (citizenship)
Residence: (city) Edinburgh (state/country) GB
Post Office Address: Tree tops , 29 Gillespie Road, Colinton Edinburgh
(Zip Code) EH13 0NW
4. Inventor's Signature: Volker P. Mannheim Date: 5/7/01
Inventor: Volker P MANNHEIM DE
(first) MI (last) (citizenship)
Residence: (city) Jever (state/country) Germany
Post Office Address: Grosse Wasserfortstr 4, Jever Deutschland
(Zip Code) D26441
5. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
6. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
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Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
8. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
9. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____
10. Inventor's Signature: _____ Date: _____
Inventor: _____
(first) MI (last) (citizenship)
Residence: (city) _____ (state/country) _____
Post Office Address: _____
(Zip Code) _____

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